

## FEATURES

5 kV rms isolated RS-485/RS-422 transceiver, configurable as half or full duplex  
 isoPower integrated isolated dc-to-dc converter  
 $\pm 15$  kV ESD protection on RS-485 input/output pins  
 Complies with ANSI/TIA/EIA-485-A-98 and ISO 8482:1987(E)  
 Data rate: 16 Mbps (ADM2682E), 500 kbps (ADM2687E)  
 5 V or 3.3 V operation  
 Connect up to 256 nodes on one bus  
 Open- and short-circuit, fail-safe receiver inputs  
 High common-mode transient immunity:  $>25$  kV/ $\mu$ s  
 Thermal shutdown protection  
 Safety and regulatory approvals  
 UL recognition  
 5000 V rms for 1 minute per UL 1577  
 CSA Component Acceptance Notice #5A (pending)  
 IEC 60601-1: 400 V rms (basic), 250 V rms (reinforced)  
 IEC 60950-1: 600 V rms (basic), 380 V rms (reinforced)  
 VDE Certificates of Conformity  
 DIN V VDE V 0884-10 (VDE V 0884-10): 2006-12  
 $V_{IORM} = 846$  V peak  
 Operating temperature range:  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$   
 16-lead wide-body SOIC with  $>8$  mm creepage and clearance

## APPLICATIONS

Isolated RS-485/RS-422 interfaces  
 Industrial field networks  
 Multipoint data transmission systems

## GENERAL DESCRIPTION

The ADM2682E/ADM2687E are fully integrated 5 kV rms signal and power isolated data transceivers with  $\pm 15$  kV ESD protection and are suitable for high speed communication on multipoint transmission lines. The ADM2682E/ADM2687E include an integrated 5 kV rms isolated dc-to-dc power supply that eliminates the need for an external dc-to-dc isolation block.

They are designed for balanced transmission lines and comply with ANSI/TIA/EIA-485-A-98 and ISO 8482:1987(E).

The devices integrate Analog Devices, Inc., iCoupler® technology to combine a 3-channel isolator, a three-state differential line driver, a differential input receiver, and Analog Devices isoPower® dc-to-dc converter into a single package. The devices are powered by a single 5 V or 3.3 V supply, realizing a fully integrated signal and power isolated RS-485 solution.

Rev. C

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## FUNCTIONAL BLOCK DIAGRAM

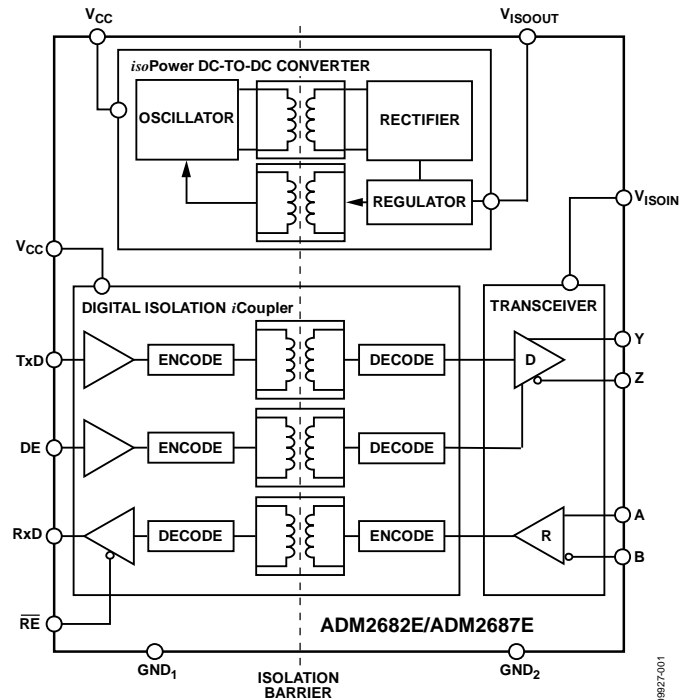


Figure 1.

The ADM2682E/ADM2687E drivers have an active high enable. An active low receiver enable is also provided, which causes the receiver output to enter a high impedance state when disabled.

The devices have current limiting and thermal shutdown features to protect against output short circuits and situations where bus contention may cause excessive power dissipation. The parts are fully specified over the industrial temperature range and are available in a highly integrated, 16-lead, wide-body SOIC package with  $>8$  mm creepage and clearance.

The ADM2682E/ADM2687E contain isoPower technology that uses high frequency switching elements to transfer power through the transformer. Special care must be taken during printed circuit board (PCB) layout to meet emissions standards. Refer to AN-0971 Application Note, Recommendations for Control of Radiated Emissions with isoPower Devices, for details on board layout considerations.

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## REVISION HISTORY

### 6/15—Rev. B to Rev. C

Changes to Figure 1 .....	1
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### 11/13—Rev. A to Rev. B

Change to Features Section .....	1
Change to Table 5 .....	5
Changes to VDE 0884-10 Insulation Characteristics Section .....	6

### 6/13—Rev. 0 to Rev. A

Updated UL and VDE Certification (Throughout).....	1
Updated Outline Dimensions .....	22
Changes to Ordering Guide .....	22

### 7/11—Revision 0: Initial Version

## SPECIFICATIONS

All voltages are relative to their respective ground;  $3.0 \leq V_{CC} \leq 5.5$  V. All minimum/maximum specifications apply over the entire recommended operation range, unless otherwise noted. All typical specifications are at  $T_A = 25^\circ\text{C}$ ,  $V_{CC} = 5$  V unless otherwise noted.

Table 1.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
<b>ADM2687E SUPPLY CURRENT</b> Data Rate $\leq 500$ kbps	$I_{CC}$		90 72 125 98		mA mA mA mA mA	$V_{CC} = 3.3$ V, 100 $\Omega$ load between Y and Z $V_{CC} = 5$ V, 100 $\Omega$ load between Y and Z $V_{CC} = 3.3$ V, 54 $\Omega$ load between Y and Z $V_{CC} = 5$ V, 54 $\Omega$ load between Y and Z 120 $\Omega$ load between Y and Z
<b>ADM2682E SUPPLY CURRENT</b> Data Rate = 16 Mbps  Data Rate = 16 Mbps, $4.5 \leq V_{CC} \leq 5.5$ V	$I_{CC}$			175 260 130 200	mA mA mA mA	120 $\Omega$ load between Y and Z 54 $\Omega$ load between Y and Z 120 $\Omega$ load between Y and Z 54 $\Omega$ load between Y and Z
<b>ISOLATED SUPPLY VOLTAGE</b>	$V_{ISOOUT}$		3.3		V	
<b>DRIVER</b>						
Differential Outputs						
Differential Output Voltage, Loaded	$ V_{OD2} $	2.0		3.6	V	$R_L = 100 \Omega$ (RS-422), see Figure 29
		1.5		3.6	V	$R_L = 54 \Omega$ (RS-485), see Figure 29
	$ V_{OD3} $	1.5		3.6	V	$-7 \text{ V} \leq V_{TEST1} \leq 12 \text{ V}$ , see Figure 30
$\Delta V_{OD} $ for Complementary Output States	$\Delta V_{OD} $			0.2	V	$R_L = 54 \Omega$ or 100 $\Omega$ , see Figure 29
Common-Mode Output Voltage	$V_{OC}$			3.0	V	$R_L = 54 \Omega$ or 100 $\Omega$ , see Figure 29
$\Delta V_{OC} $ for Complementary Output States	$\Delta V_{OC} $			0.2	V	$R_L = 54 \Omega$ or 100 $\Omega$ , see Figure 29
Short-Circuit Output Current	$I_{OS}$			200	mA	
Output Leakage Current (Y, Z)	$I_O$			30	$\mu\text{A}$	$DE = 0 \text{ V}$ , $\overline{RE} = 0 \text{ V}$ , $V_{CC} = 0 \text{ V}$ or 3.6 V, $V_{IN} = 12 \text{ V}$
				-30	$\mu\text{A}$	$DE = 0 \text{ V}$ , $\overline{RE} = 0 \text{ V}$ , $V_{CC} = 0 \text{ V}$ or 3.6 V, $V_{IN} = -7 \text{ V}$
Logic Inputs DE, $\overline{RE}$ , TxD						
Input Threshold Low	$V_{IL}$	$0.27 V_{CC}$			V	DE, $\overline{RE}$ , TxD
Input Threshold High	$V_{IH}$			$0.7 V_{CC}$	V	DE, $\overline{RE}$ , TxD
Input Current	$I_I$	-10	0.01	10	$\mu\text{A}$	DE, $\overline{RE}$ , TxD
<b>RECEIVER</b>						
Differential Inputs						
Differential Input Threshold Voltage	$V_{TH}$	-200	-125	-30	mV	$-7 \text{ V} < V_{CM} < +12 \text{ V}$
Input Voltage Hysteresis	$V_{HYS}$		15		mV	$V_{OC} = 0 \text{ V}$
Input Current (A, B)	$I_I$			125	$\mu\text{A}$	$DE = 0 \text{ V}$ , $V_{CC} = 0 \text{ V}$ or 3.6 V, $V_{IN} = 12 \text{ V}$
		-100			$\mu\text{A}$	$DE = 0 \text{ V}$ , $V_{CC} = 0 \text{ V}$ or 3.6 V, $V_{IN} = -7 \text{ V}$
Line Input Resistance	$R_{IN}$	96			k $\Omega$	$-7 \text{ V} < V_{CM} < +12 \text{ V}$
Logic Outputs						
Output Voltage Low	$V_{OL}$		0.2	0.4	V	$I_O = 1.5 \text{ mA}$ , $V_A - V_B = -0.2 \text{ V}$
Output Voltage High	$V_{OH}$	$V_{CC} - 0.3$	$V_{CC} - 0.2$		V	$I_O = -1.5 \text{ mA}$ , $V_A - V_B = 0.2 \text{ V}$
Short-Circuit Current				100	mA	
<b>COMMON-MODE TRANSIENT IMMUNITY<sup>1</sup></b>		25			kV/ $\mu\text{s}$	$V_{CM} = 1 \text{ kV}$ , transient magnitude = 800 V

<sup>1</sup> CM is the maximum common-mode voltage slew rate that can be sustained while maintaining specification-compliant operation.  $V_{CM}$  is the common-mode potential difference between the logic and bus sides. The transient magnitude is the range over which the common-mode is slewed. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

**ADM2682E TIMING SPECIFICATIONS**T<sub>A</sub> = -40°C to +85°C.

Table 2.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DRIVER						
Maximum Data Rate		16			Mbps	
Propagation Delay, Low to High	t <sub>DPLH</sub>		63	100	ns	R <sub>L</sub> = 54 Ω, C <sub>L1</sub> = C <sub>L2</sub> = 100 pF, see Figure 31 and Figure 35
Propagation Delay, High to Low	t <sub>DPHL</sub>		64	100	ns	R <sub>L</sub> = 54 Ω, C <sub>L1</sub> = C <sub>L2</sub> = 100 pF, see Figure 31 and Figure 35
Output Skew	t <sub>SKEW</sub>		1	8	ns	R <sub>L</sub> = 54 Ω, C <sub>L1</sub> = C <sub>L2</sub> = 100 pF, see Figure 31 and Figure 35
Rise Time/Fall Time	t <sub>DR</sub> , t <sub>DF</sub>			15	ns	R <sub>L</sub> = 54 Ω, C <sub>L1</sub> = C <sub>L2</sub> = 100 pF, see Figure 31 and Figure 35
Enable Time	t <sub>ZL</sub> , t <sub>ZH</sub>			120	ns	R <sub>L</sub> = 110 Ω, C <sub>L</sub> = 50 pF, see Figure 32 and Figure 37
Disable Time	t <sub>LZ</sub> , t <sub>HZ</sub>			150	ns	R <sub>L</sub> = 110 Ω, C <sub>L</sub> = 50 pF, see Figure 32 and Figure 37
RECEIVER						
Propagation Delay, Low to High	t <sub>RPLH</sub>		94	110	ns	C <sub>L</sub> = 15 pF, see Figure 33 and Figure 36
Propagation Delay, High to Low	t <sub>RPHL</sub>		95	110	ns	C <sub>L</sub> = 15 pF, see Figure 33 and Figure 36
Output Skew <sup>1</sup>	t <sub>SKEW</sub>		1	12	ns	C <sub>L</sub> = 15 pF, see Figure 33 and Figure 36
Enable Time	t <sub>ZL</sub> , t <sub>ZH</sub>			15	ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 15 pF, see Figure 34 and Figure 38
Disable Time	t <sub>LZ</sub> , t <sub>HZ</sub>			15	ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 15 pF, see Figure 34 and Figure 38

<sup>1</sup> Guaranteed by design.**ADM2687E TIMING SPECIFICATIONS**T<sub>A</sub> = -40°C to +85°C.

Table 3.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
DRIVER						
Maximum Data Rate		500			kbps	
Propagation Delay, Low to High	t <sub>DPLH</sub>	250	503	700	ns	R <sub>L</sub> = 54 Ω, C <sub>L1</sub> = C <sub>L2</sub> = 100 pF, see Figure 31 and Figure 35
Propagation Delay, High to Low	t <sub>DPHL</sub>	250	510	700	ns	R <sub>L</sub> = 54 Ω, C <sub>L1</sub> = C <sub>L2</sub> = 100 pF, see Figure 31 and Figure 35
Output Skew	t <sub>SKEW</sub>		7	100	ns	R <sub>L</sub> = 54 Ω, C <sub>L1</sub> = C <sub>L2</sub> = 100 pF, see Figure 31 and Figure 35
Rise Time/Fall Time	t <sub>DR</sub> , t <sub>DF</sub>	200		1100	ns	R <sub>L</sub> = 54 Ω, C <sub>L1</sub> = C <sub>L2</sub> = 100 pF, see Figure 31 and Figure 35
Enable Time	t <sub>ZL</sub> , t <sub>ZH</sub>			2.5	μs	R <sub>L</sub> = 110 Ω, C <sub>L</sub> = 50 pF, see Figure 32 and Figure 37
Disable Time	t <sub>LZ</sub> , t <sub>HZ</sub>			200	ns	R <sub>L</sub> = 110 Ω, C <sub>L</sub> = 50 pF, see Figure 32 and Figure 37
RECEIVER						
Propagation Delay, Low to High	t <sub>RPLH</sub>		91	200	ns	C <sub>L</sub> = 15 pF, see Figure 33 and Figure 36
Propagation Delay, High to Low	t <sub>RPHL</sub>		95	200	ns	C <sub>L</sub> = 15 pF, see Figure 33 and Figure 36
Output Skew	t <sub>SKEW</sub>		4	30	ns	C <sub>L</sub> = 15 pF, see Figure 33 and Figure 36
Enable Time	t <sub>ZL</sub> , t <sub>ZH</sub>			15	ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 15 pF, see Figure 34 and Figure 38
Disable Time	t <sub>LZ</sub> , t <sub>HZ</sub>			15	ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 15 pF, see Figure 34 and Figure 38

**PACKAGE CHARACTERISTICS**

Table 4.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions/Comments
Resistance (Input-to-Output) <sup>1</sup>	R <sub>I-O</sub>		10 <sup>12</sup>		Ω	
Capacitance (Input-to-Output) <sup>1</sup>	C <sub>I-O</sub>		3		pF	f = 1 MHz
Input Capacitance <sup>2</sup>	C <sub>I</sub>		4		pF	

<sup>1</sup> Device considered a 2-terminal device: short together Pin 1 to Pin 8 and short together Pin 9 to Pin 16.<sup>2</sup> Input capacitance is from any input data pin to ground.

**REGULATORY INFORMATION**

Table 5. ADM2682E/ADM2687E Approvals

Organization	Approval Type
<b>UL</b>	To be recognized under the UL 1577 Component Recognition Program of Underwriters Laboratories, Inc. Single protection, 5000 V rms isolation voltage. In accordance with UL 1577, each ADM2682E/ADM2687E is proof tested by applying an insulation test voltage $\geq 6000$ V rms for 1 second.
<b>CSA (Pending)</b>	To be approved under CSA Component Acceptance Notice #5A. Reinforced insulation per IEC 60601-1, 250 V rms (353 V peak) maximum working voltage. Basic insulation per IEC 60601-1, 400 V rms (566 V peak) maximum working voltage. Reinforced insulation per CSA 60950-1-07 and IEC 60950-1, 380 V rms (537 V peak) maximum working voltage. Basic insulation per CSA 60950-1-07 and IEC 60950-1, 600 V rms (848 V peak) maximum working voltage.
<b>VDE</b>	Certified according to DIN V VDE V 0884-10 (VDE 0884-10): 2006-12. In accordance with DIN EN 60747-5-2, each ADM2682E/ADM2687E is proof tested by applying an insulation test voltage $\geq 1590$ V peak for 1 second.

**INSULATION AND SAFETY-RELATED SPECIFICATIONS**

Table 6.

Parameter	Symbol	Value	Unit	Test Conditions/Comments
Rated Dielectric Insulation Voltage		5000	V rms	1-minute duration
Minimum External Air Gap (Clearance)	L(I01)	>8.0	mm	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage)	L(I02)	>8.0	mm	Measured from input terminals to output terminals, shortest distance along body
Minimum Internal Gap (Internal Clearance)		0.017 min	mm	Insulation distance through insulation
Tracking Resistance (Comparative Tracking Index)	CTI	>175	V	DIN IEC 112/VDE 0303-1
Isolation Group		IIIa		Material Group (DIN VDE 0110:1989-01, Table 1)

**VDE 0884-10 INSULATION CHARACTERISTICS**

This isolator is suitable for reinforced electrical isolation only within the safety limit data. Maintenance of the safety data must be ensured by means of protective circuits.

**Table 7.**

<b>Description</b>	<b>Test Conditions/Comments</b>	<b>Symbol</b>	<b>Characteristic</b>	<b>Unit</b>
<b>CLASSIFICATIONS</b> Installation Classification per DIN VDE 0110 for Rated Mains Voltage ≤300 V rms ≤450 V rms ≤600 V rms Climatic Classification Pollution Degree	Table 1 of DIN VDE 0110		I to IV I to III I to II 40/85/21 2	
<b>VOLTAGE</b> Maximum Working Insulation Voltage Input-to-Output Test Voltage Method b1 Method a After Environmental Tests, Subgroup 1 After Input and/or Safety Test, Subgroup 2/Subgroup 3 Highest Allowable Overvoltage	$V_{IORM} \times 1.875 = V_{PR}$ , 100% production tested, $t_m = 1$ sec, partial discharge < 5 pC  $V_{IORM} \times 1.6 = V_{PR}$ , $t_m = 60$ sec, partial discharge < 5 pC $V_{IORM} \times 1.2 = V_{PR}$ , $t_m = 60$ sec, partial discharge < 5 pC  Transient overvoltage, $t_{TR} = 10$ sec	$V_{IORM}$ $V_{PR}$   $V_{TR}$	846 1590 1375 1018 6000	V peak V peak V peak V peak V peak
<b>SAFETY-LIMITING VALUES</b> Case Temperature Input Current Output Current Insulation Resistance at $T_s$	Maximum value allowed in the event of a failure   $V_{IO} = 500$ V	$T_s$ $I_{S, INPUT}$ $I_{S, OUTPUT}$ $R_s$	150 265 335 >10 <sup>9</sup>	°C mA mA Ω

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted. All voltages are relative to their respective ground.

Table 8.

Parameter	Rating
$V_{CC}$	-0.5 V to +7 V
Digital Input Voltage (DE, $\overline{RE}$ , TxD)	-0.5 V to $V_{DD} + 0.5$ V
Digital Output Voltage (Rx/D)	-0.5 V to $V_{DD} + 0.5$ V
Driver Output/Receiver Input Voltage	-9 V to +14 V
Operating Temperature Range	-40°C to +85°C
Storage Temperature Range	-55°C to +150°C
ESD (Human Body Model) on A, B, Y, and Z pins	±15 kV
ESD (Human Body Model) on Other Pins	±2 kV
Thermal Resistance $\theta_{JA}$	52°C/W
Lead Temperature	
Soldering (10 sec)	260°C
Vapor Phase (60 sec)	215°C
Infrared (15 sec)	220°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

Table 9. Maximum Continuous Working Voltage<sup>1</sup>

Parameter	Max	Unit	Reference Standard
AC Voltage			
Bipolar Waveform	424	V peak	All certifications, 50-year minimum lifetime
Unipolar Waveform			
Basic Insulation	600	V peak	Maximum approved working voltage per IEC 60950-1
Reinforced Insulation	537	V peak	
DC Voltage			
Basic Insulation	600	V peak	Maximum approved working voltage per IEC 60950-1
Reinforced Insulation	537	V peak	

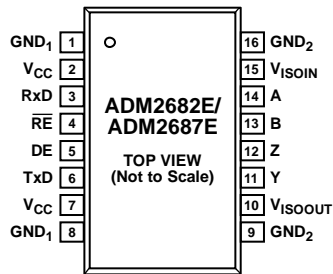
<sup>1</sup> Refers to continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

## ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



NOTES  
 1. PIN 10 AND PIN 15 MUST BE CONNECTED EXTERNALLY.

09827-002

Figure 2. Pin Configuration

Table 10. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	GND <sub>1</sub>	Ground, Logic Side.
2	V <sub>CC</sub>	Logic Side Power Supply. It is recommended that a 0.1 μF and a 0.01 μF decoupling capacitor be fitted between Pin 2 and Pin 1.
3	RxD	Receiver Output Data. This output is high when (A – B) ≥ –30 mV and low when (A – B) ≤ –200 mV. The output is tristated when the receiver is disabled, that is, when RE is driven high.
4	RE	Receiver Enable Input. This is an active-low input. Driving this input low enables the receiver, while driving it high disables the receiver.
5	DE	Driver Enable Input. Driving this input high enables the driver, while driving it low disables the driver.
6	TxD	Driver Input. Data to be transmitted by the driver is applied to this input.
7	V <sub>CC</sub>	Logic Side Power Supply. It is recommended that a 0.1 μF and a 10 μF decoupling capacitor be fitted between Pin 7 and Pin 8.
8	GND <sub>1</sub>	Ground, Logic Side.
9	GND <sub>2</sub>	Ground, Bus Side.
10	V <sub>ISOOUT</sub>	Isolated Power Supply Output. This pin must be connected externally to V <sub>ISOIN</sub> . It is recommended that a reservoir capacitor of 10 μF and a decoupling capacitor of 0.1 μF be fitted between Pin 10 and Pin 9.
11	Y	Driver Noninverting Output
12	Z	Driver Inverting Output
13	B	Receiver Inverting Input.
14	A	Receiver Noninverting Input.
15	V <sub>ISOIN</sub>	Isolated Power Supply Input. This pin must be connected externally to V <sub>ISOOUT</sub> . It is recommended that a 0.1 μF and a 0.01 μF decoupling capacitor be fitted between Pin 15 and Pin 16.
16	GND <sub>2</sub>	Ground, Bus Side.



### TYPICAL PERFORMANCE CHARACTERISTICS

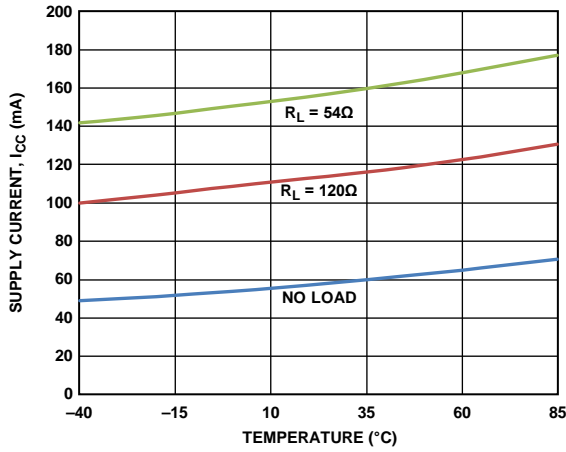


Figure 3. ADM2682E Supply Current ( $I_{CC}$ ) vs. Temperature (Data Rate = 16 Mbps, DE = 3.3 V,  $V_{CC}$  = 3.3 V)

09827-203

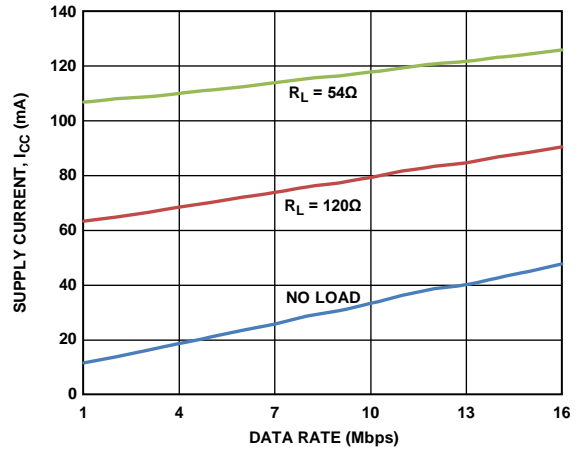


Figure 6. ADM2682E Supply Current ( $I_{CC}$ ) vs. Data Rate ( $T_A$  = 25°C, DE = 5 V,  $V_{CC}$  = 5 V)

09827-206

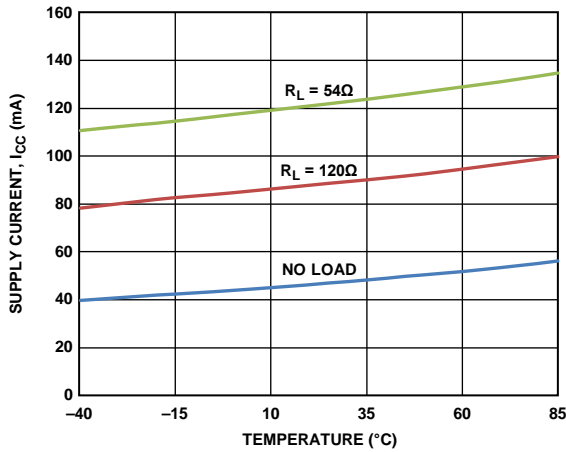


Figure 4. ADM2682E Supply Current ( $I_{CC}$ ) vs. Temperature (Data Rate = 16 Mbps, DE = 5 V,  $V_{CC}$  = 5 V)

09827-204

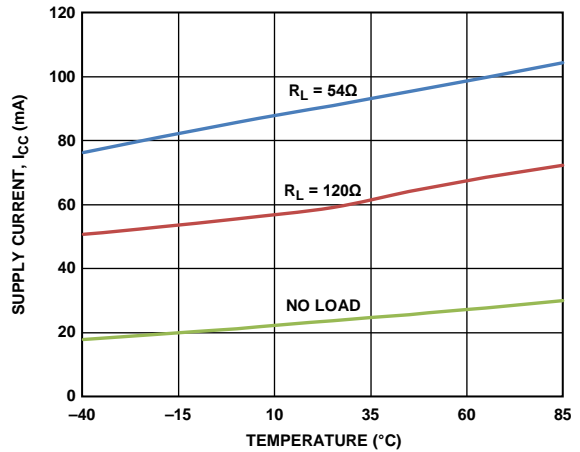


Figure 7. ADM2687E Supply Current ( $I_{CC}$ ) vs. Temperature (Data Rate = 500 kbps, DE = 5 V,  $V_{CC}$  = 5 V)

09827-207

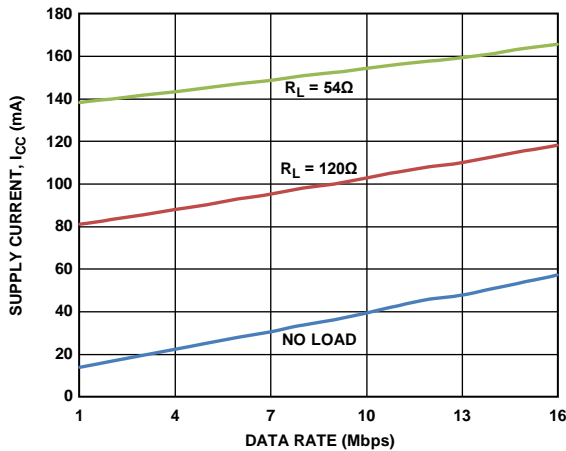


Figure 5. ADM2682E Supply Current ( $I_{CC}$ ) vs. Data Rate ( $T_A$  = 25°C, DE = 3.3 V,  $V_{CC}$  = 3.3 V)

09827-205

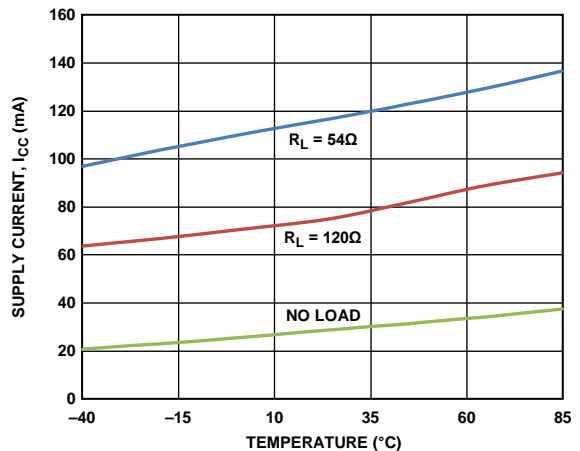


Figure 8. ADM2687E Supply Current ( $I_{CC}$ ) vs. Temperature (Data Rate = 500 kbps, DE = 3.3 V,  $V_{CC}$  = 3.3 V)

09827-208

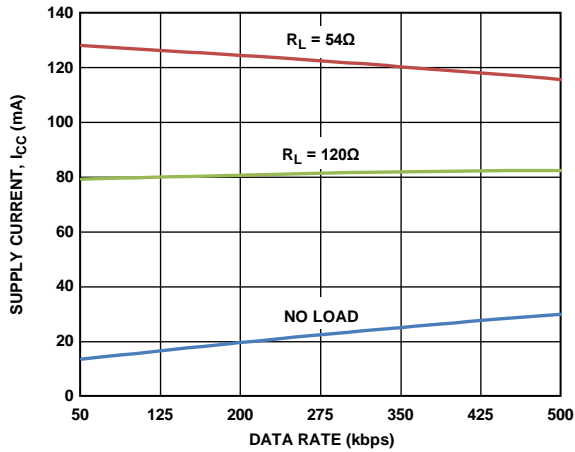


Figure 9. ADM2687E Supply Current ( $I_{CC}$ ) vs. Data Rate ( $T_A = 25^\circ\text{C}$ ,  $DE = 3.3\text{ V}$ ,  $V_{CC} = 3.3\text{ V}$ )

09927-209

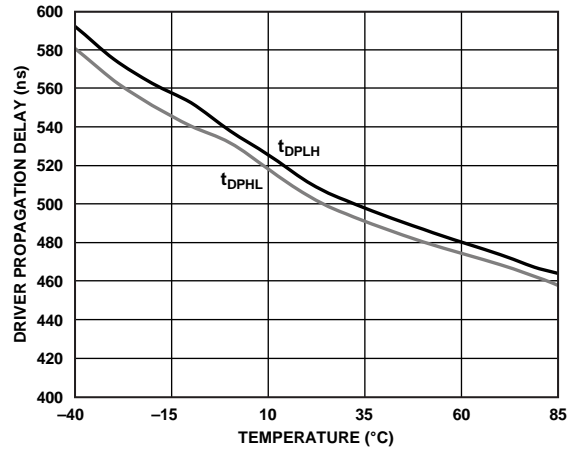


Figure 12. ADM2687E Differential Driver Propagation Delay vs. Temperature

09927-108

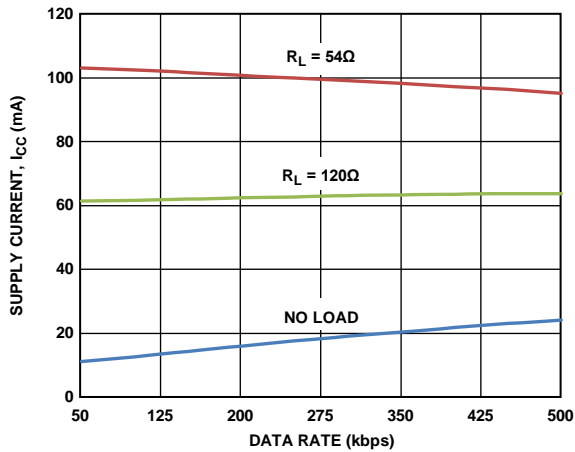


Figure 10. ADM2687E Supply Current ( $I_{CC}$ ) vs. Data Rate ( $T_A = 25^\circ\text{C}$ ,  $DE = 5\text{ V}$ ,  $V_{CC} = 5\text{ V}$ )

09927-210

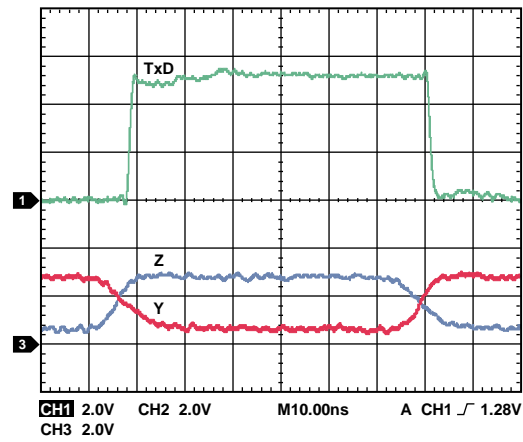


Figure 13. ADM2682E Driver Propagation Delay

09927-109

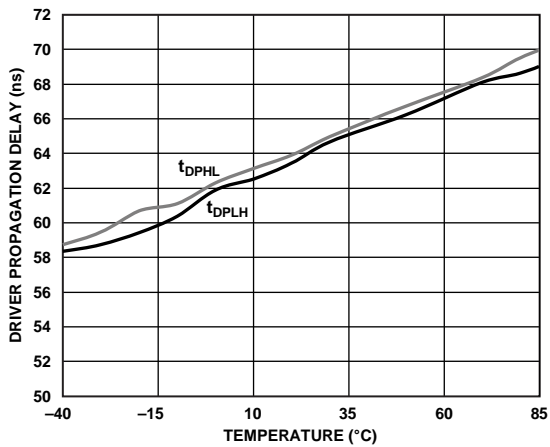


Figure 11. ADM2682E Differential Driver Propagation Delay vs. Temperature

09927-107

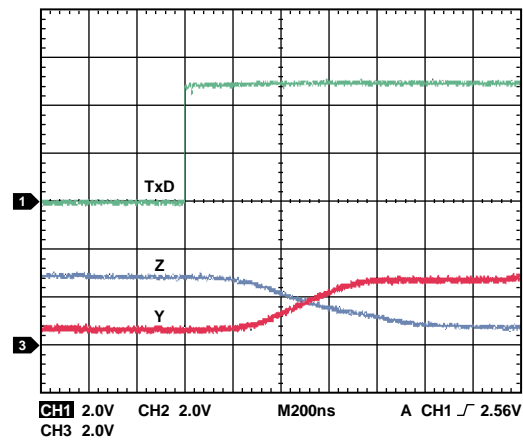


Figure 14. ADM2687E Driver Propagation Delay

09927-110

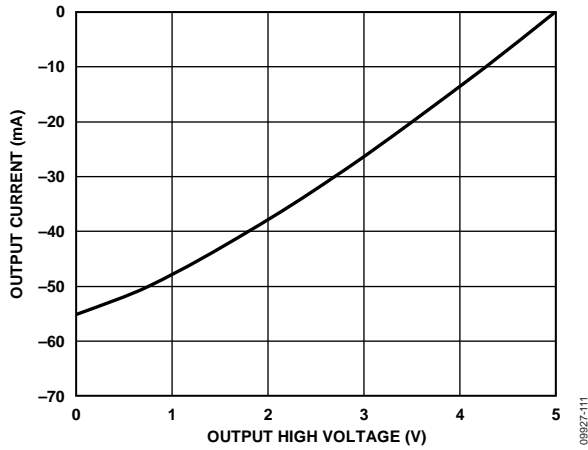


Figure 15. Receiver Output Current vs. Receiver Output High Voltage

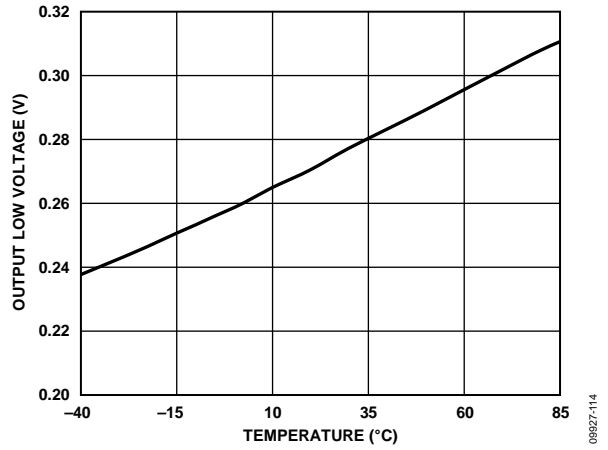


Figure 18. Receiver Output Low Voltage vs. Temperature

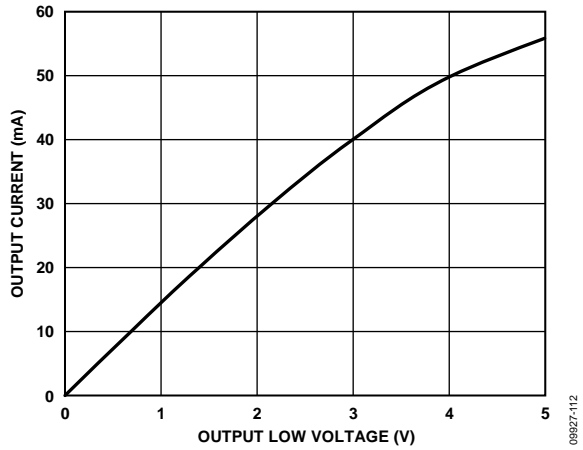


Figure 16. Receiver Output Current vs. Receiver Output Low Voltage

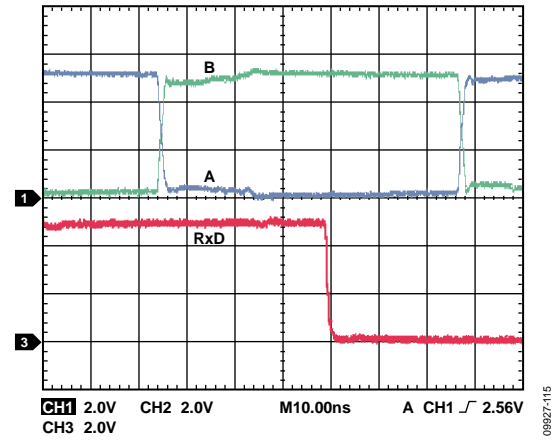


Figure 19. ADM2682E Receiver Propagation Delay

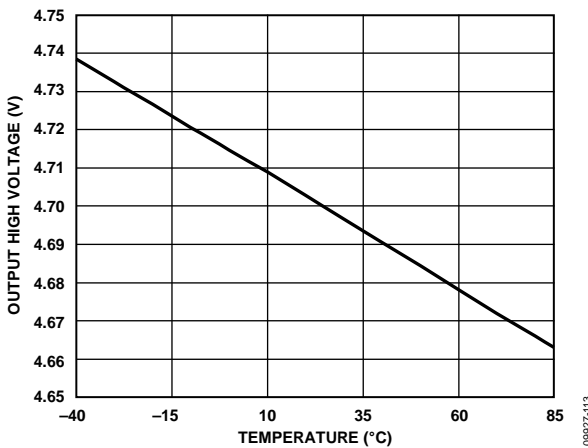


Figure 17. Receiver Output High Voltage vs. Temperature

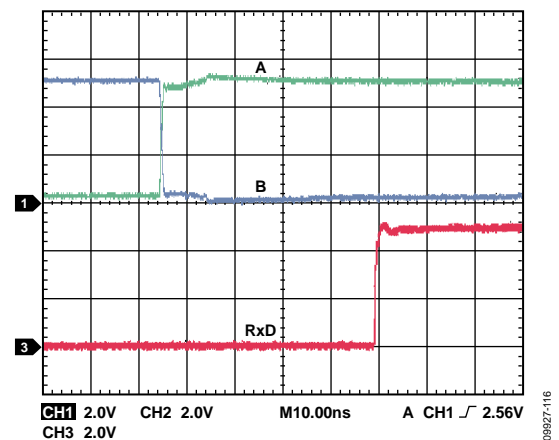


Figure 20. ADM2687E Receiver Propagation Delay

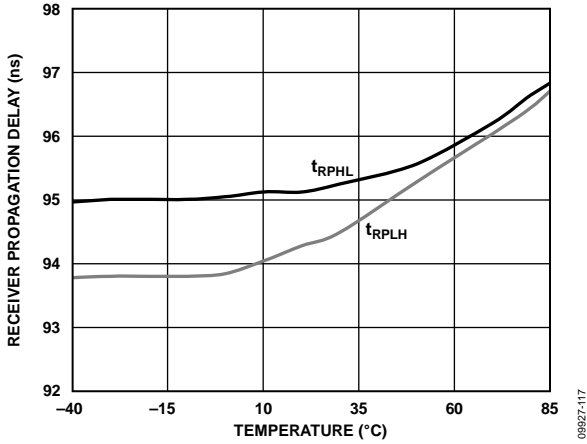


Figure 21. ADM2682E Receiver Propagation Delay vs. Temperature

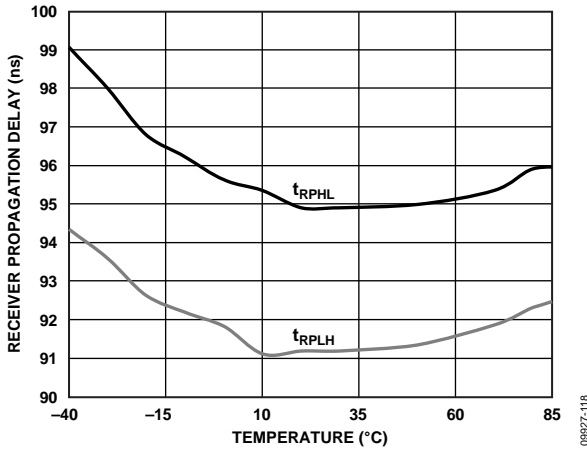


Figure 22. ADM2687E Receiver Propagation Delay vs. Temperature

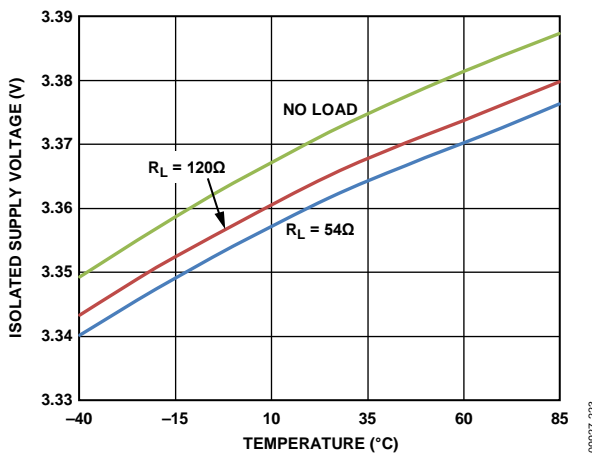


Figure 23. ADM2682E Isolated Supply Voltage vs. Temperature ( $V_{CC} = 3.3\text{ V}$ , Data Rate = 16 Mbps)

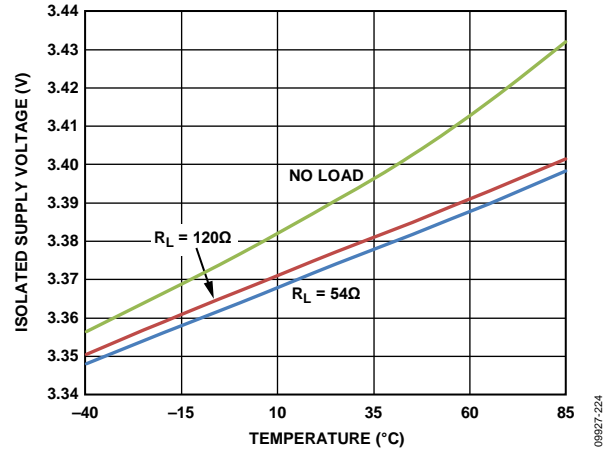


Figure 24. ADM2682E Isolated Supply Voltage vs. Temperature ( $V_{CC} = 5\text{ V}$ , Data Rate = 16 Mbps)

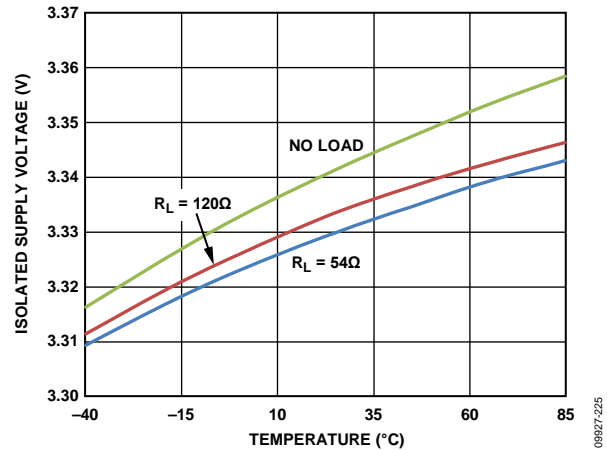


Figure 25. ADM2687E Isolated Supply Voltage vs. Temperature ( $V_{CC} = 3.3\text{ V}$ , Data Rate = 500 kbps)

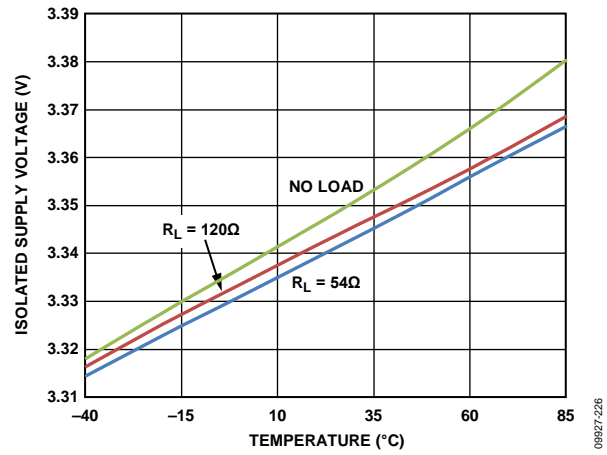


Figure 26. ADM2687E Isolated Supply Voltage vs. Temperature ( $V_{CC} = 5\text{ V}$ , Data Rate = 500 kbps)

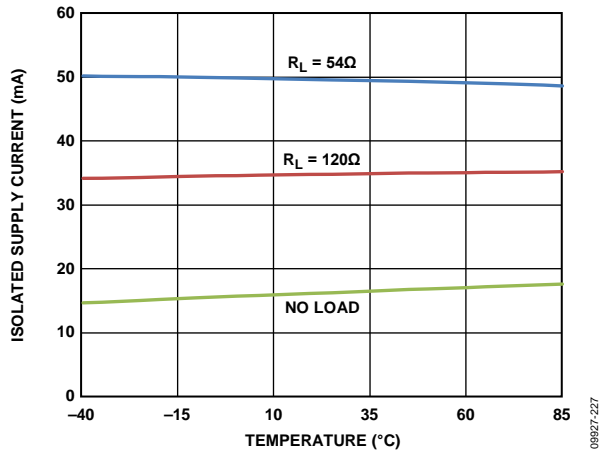


Figure 27. ADM2682E Isolated Supply Current vs. Temperature (V<sub>CC</sub> = 3.3 V, Data Rate = 16 Mbps)

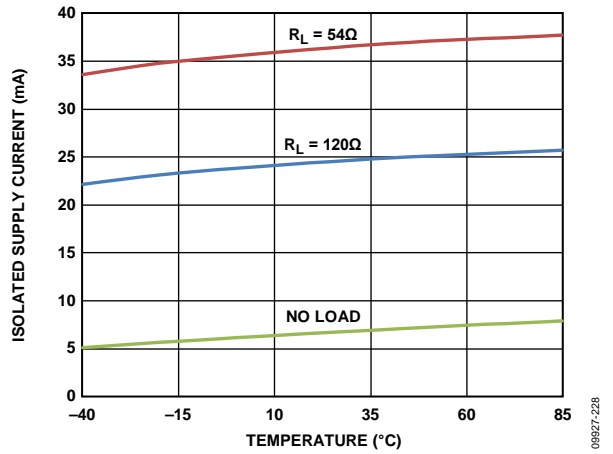


Figure 28. ADM2687E Isolated Supply Current vs. Temperature (V<sub>CC</sub> = 3.3 V, Data Rate = 500 kbps)

TEST CIRCUITS

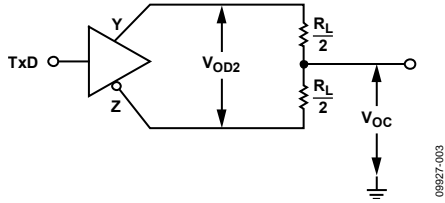


Figure 29. Driver Voltage Measurement

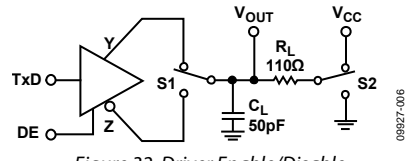


Figure 32. Driver Enable/Disable

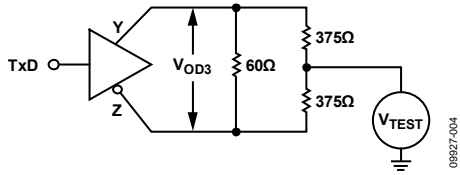


Figure 30. Driver Voltage Measurement over Common Mode

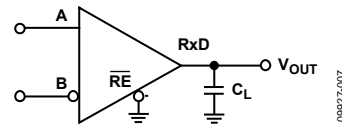


Figure 33. Receiver Propagation Delay

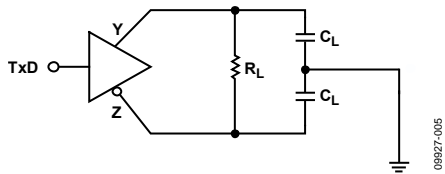


Figure 31. Driver Propagation Delay

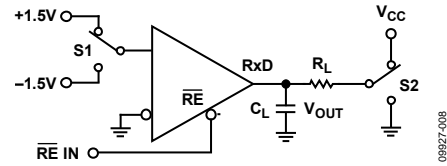


Figure 34. Receiver Enable/Disable

### SWITCHING CHARACTERISTICS

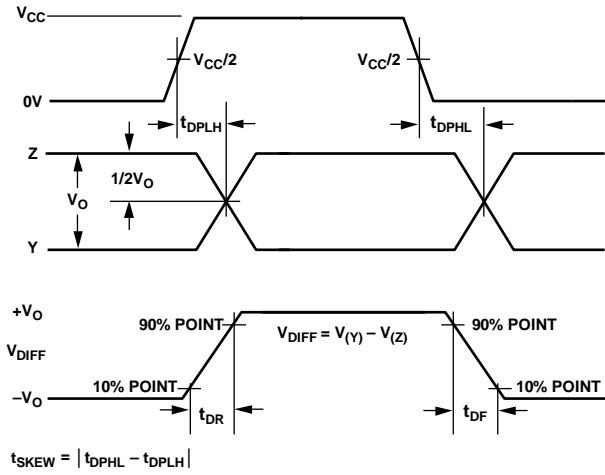


Figure 35. Driver Propagation Delay, Rise/Fall Timing

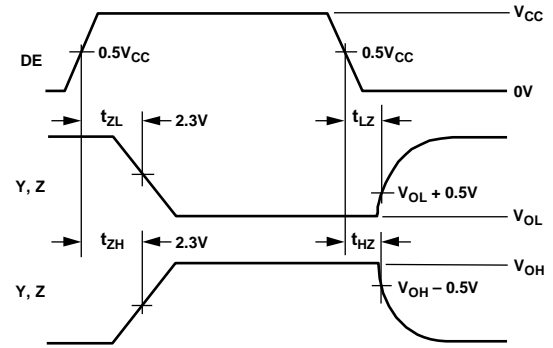


Figure 37. Driver Enable/Disable Timing

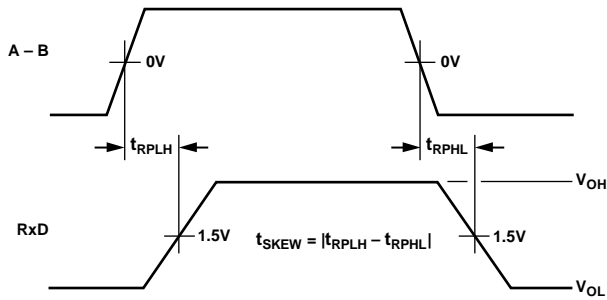


Figure 36. Receiver Propagation Delay

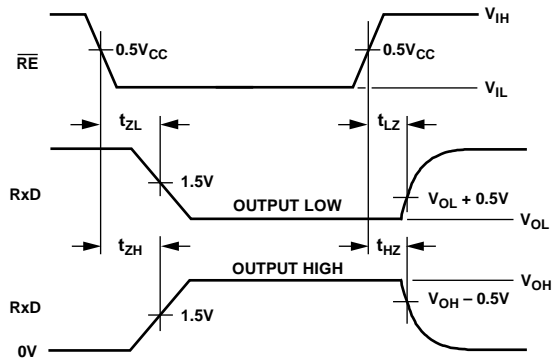


Figure 38. Receiver Enable/Disable Timing

## CIRCUIT DESCRIPTION

### SIGNAL ISOLATION

The ADM2682E/ADM2687E signal isolation of 5 kV rms is implemented on the logic side of the interface. The part achieves signal isolation by having a digital isolation section and a transceiver section (see Figure 1). Data applied to the TxD and DE pins and referenced to logic ground (GND<sub>1</sub>) are coupled across an isolation barrier to appear at the transceiver section referenced to isolated ground (GND<sub>2</sub>). Similarly, the single-ended receiver output signal, referenced to isolated ground in the transceiver section, is coupled across the isolation barrier to appear at the RxD pin referenced to logic ground.

### POWER ISOLATION

The ADM2682E/ADM2687E power isolation of 5 kV rms is implemented using an *isoPower* integrated isolated dc-to-dc converter. The dc-to-dc converter section of the ADM2682E/ADM2687E works on principles that are common to most modern power supplies. It is a secondary side controller architecture with isolated pulse-width modulation (PWM) feedback. V<sub>CC</sub> power is supplied to an oscillating circuit that switches current into a chip-scale air core transformer. Power transferred to the secondary side is rectified and regulated to 3.3 V. The secondary (V<sub>ISO</sub>) side controller regulates the output by creating a PWM control signal that is sent to the primary (V<sub>CC</sub>) side by a dedicated *iCoupler* (5 kV rms signal isolated) data channel. The PWM modulates the oscillator circuit to control the power being sent to the secondary side. Feedback allows for significantly higher power and efficiency.

### TRUTH TABLES

The truth tables in this section use the abbreviations found in Table 11.

Table 11. Truth Table Abbreviations

Letter	Description
H	High level
L	Low level
X	Don't care
I	Indeterminate
Z	High impedance (off)
NC	Disconnected

Table 12. Transmitting (see Table 11 for Abbreviations)

Inputs		Outputs	
DE	TxD	Y	Z
H	H	H	L
H	L	L	H
L	X	Z	Z
X	X	Z	Z

Table 13. Receiving (see Table 11 for Abbreviations)

Inputs		Output
A – B	$\overline{RE}$	RxD
$\geq -0.03$ V	L or NC	H
$\leq -0.2$ V	L or NC	L
$-0.2$ V < A – B < $-0.03$ V	L or NC	I
Inputs open	L or NC	H
X	H	Z

### THERMAL SHUTDOWN

The ADM2682E/ADM2687E contain thermal shutdown circuitry that protects the parts from excessive power dissipation during fault conditions. Shorting the driver outputs to a low impedance source can result in high driver currents. The thermal sensing circuitry detects the increase in die temperature under this condition and disables the driver outputs. This circuitry is designed to disable the driver outputs when a die temperature of 150°C is reached. As the device cools, the drivers are reenabled at a temperature of 140°C.

### OPEN- AND SHORT-CIRCUIT, FAIL-SAFE RECEIVER INPUTS

The receiver inputs have open- and short-circuit, fail-safe features that ensure that the receiver output is high when the inputs are open or shorted. During line-idle conditions, when no driver on the bus is enabled, the voltage across a terminating resistance at the receiver input decays to 0 V. With traditional transceivers, receiver input thresholds specified between  $-200$  mV and  $+200$  mV mean that external bias resistors are required on the A and B pins to ensure that the receiver outputs are in a known state. The short-circuit, fail-safe receiver input feature eliminates the need for bias resistors by specifying the receiver input threshold between  $-30$  mV and  $-200$  mV. The guaranteed negative threshold means that when the voltage between A and B decays to 0 V, the receiver output is guaranteed to be high.

### DC CORRECTNESS AND MAGNETIC FIELD IMMUNITY

The digital signals transmit across the isolation barrier using *iCoupler* technology. This technique uses chip-scale transformer windings to couple the digital signals magnetically from one side of the barrier to the other. Digital inputs are encoded into waveforms that are capable of exciting the primary transformer winding. At the secondary winding, the induced waveforms are decoded into the binary value that was originally transmitted.

Positive and negative logic transitions at the isolator input cause narrow ( $\sim 1$  ns) pulses to be sent to the decoder via the transformer. The decoder is bistable and is, therefore, either set or reset by the pulses, indicating input logic transitions. In the absence of logic transitions at the input for more than 1  $\mu$ s, periodic sets of refresh pulses indicative of the correct input state are sent to ensure dc correctness at the output. If the decoder receives no internal pulses of more than approximately 5  $\mu$ s, the input side



is assumed to be unpowered or nonfunctional, in which case, the isolator output is forced to a default state by the watchdog timer circuit.

This situation should occur in the ADM2682E/ADM2687E devices only during power-up and power-down operations. The limitation on the ADM2682E/ADM2687E magnetic field immunity is set by the condition in which induced voltage in the transformer receiving coil is sufficiently large to either falsely set or reset the decoder. The following analysis defines the conditions under which this can occur.

The 3.3 V operating condition of the ADM2682E/ADM2687E is examined because it represents the most susceptible mode of operation. The pulses at the transformer output have an amplitude of >1.0 V. The decoder has a sensing threshold of about 0.5 V, thus establishing a 0.5 V margin in which induced voltages can be tolerated. The voltage induced across the receiving coil is given by

$$V = (-d\beta/dt)\Sigma\pi r_n^2; n = 1, 2, \dots, N$$

where:

$\beta$  is magnetic flux density (gauss).

$N$  is the number of turns in the receiving coil.

$r_n$  is the radius of the  $n^{\text{th}}$  turn in the receiving coil (cm).

Given the geometry of the receiving coil in the ADM2682E/ADM2687E and an imposed requirement that the induced voltage be, at most, 50% of the 0.5 V margin at the decoder, a maximum allowable magnetic field is calculated as shown in Figure 39.

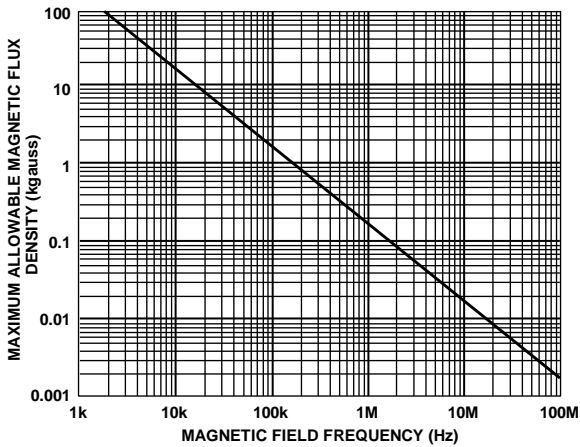


Figure 39. Maximum Allowable External Magnetic Flux Density

For example, at a magnetic field frequency of 1 MHz, the maximum allowable magnetic field of 0.2 kgauss induces a voltage of 0.25 V at the receiving coil. This is about 50% of the sensing threshold and does not cause a faulty output transition. Similarly, if such an event occurs during a transmitted pulse (and is of the worst-case polarity), it reduces the received pulse from >1.0 V to 0.75 V, which is still well above the 0.5 V sensing threshold of the decoder.

The preceding magnetic flux density values correspond to specific current magnitudes at given distances from the ADM2682E/ADM2687E transformers. Figure 40 expresses these allowable current magnitudes as a function of frequency for selected distances. As shown in Figure 40, the ADM2682E/ADM2687E are extremely immune and can be affected only by extremely large currents operated at high frequency very close to the component. For the 1 MHz example, a 0.5 kA current must be placed 5 mm away from the ADM2682E/ADM2687E to affect component operation.

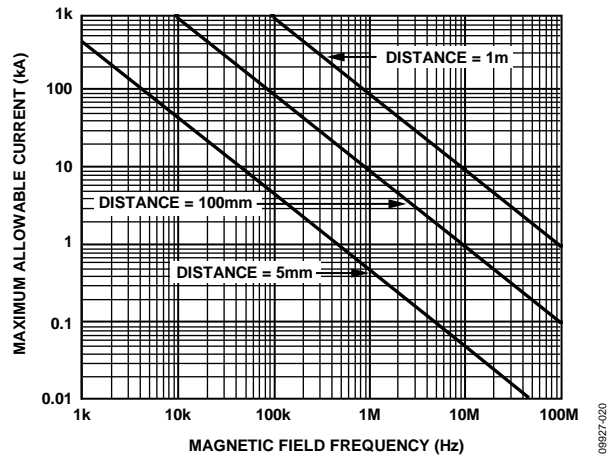


Figure 40. Maximum Allowable Current for Various Current-to-ADM2682E/ADM2687E Spacings

Note that in combinations of strong magnetic field and high frequency, any loops formed by PCB traces can induce error voltages sufficiently large to trigger the thresholds of succeeding circuitry. Take care in the layout of such traces to avoid this possibility.

## APPLICATIONS INFORMATION

### PCB LAYOUT

The [ADM2682E/ADM2687E](#) isolated RS-422/RS-485 transceiver contains an *isoPower* integrated dc-to-dc converter, requiring no external interface circuitry for the logic interfaces. Power supply bypassing is required at the input and output supply pins (see Figure 41). The power supply section of the [ADM2682E/ADM2687E](#) uses an 180 MHz oscillator frequency to pass power efficiently through its chip-scale transformers. In addition, the normal operation of the data section of the *iCoupler* introduces switching transients on the power supply pins.

Bypass capacitors are required for several operating frequencies. Noise suppression requires a low inductance, high frequency capacitor, whereas ripple suppression and proper regulation require a large value capacitor. These capacitors are connected between Pin 1 (GND<sub>1</sub>) and Pin 2 (V<sub>CC</sub>) and Pin 7 (V<sub>CC</sub>) and Pin 8 (GND<sub>1</sub>) for V<sub>CC</sub>. The V<sub>ISOIN</sub> and V<sub>ISOOUT</sub> capacitors are connected between Pin 9 (GND<sub>2</sub>) and Pin 10 (V<sub>ISOOUT</sub>) and Pin 15 (V<sub>ISOIN</sub>) and Pin 16 (GND<sub>2</sub>). To suppress noise and reduce ripple, a parallel combination of at least two capacitors is required with the smaller of the two capacitors located closest to the device. The recommended capacitor values are 0.1  $\mu\text{F}$  and 10  $\mu\text{F}$  for V<sub>ISOOUT</sub> at Pin 9 and Pin 10 and V<sub>CC</sub> at Pin 7 and Pin 8. Capacitor values of 0.01  $\mu\text{F}$  and 0.1  $\mu\text{F}$  are recommended for V<sub>ISOIN</sub> at Pin 15 and Pin 16 and V<sub>CC</sub> at Pin 1 and Pin 2. The recommended best practice is to use a very low inductance ceramic capacitor, or its equivalent, for the smaller value capacitors. The total lead length between both ends of the capacitor and the input power supply pin should not exceed 10 mm.

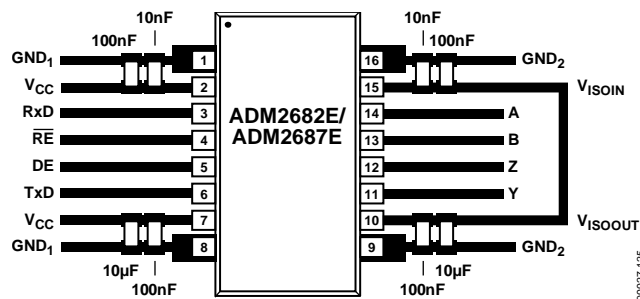


Figure 41. Recommended PCB Layout

In applications involving high common-mode transients, ensure that board coupling across the isolation barrier is minimized. Furthermore, design the board layout such that any coupling that does occur equally affects all pins on a given component side. Failure to ensure this can cause voltage differentials between pins exceeding the absolute maximum ratings for the device, thereby leading to latch-up and/or permanent damage.

The [ADM2682E/ADM2687E](#) dissipate approximately 675 mW of power when fully loaded. Because it is not possible to apply a heat sink to an isolation device, the devices primarily depend on heat dissipation into the PCB through the GND pins. If the devices are used at high ambient temperatures, provide a thermal path from the GND pins to the PCB ground plane. The board layout in Figure 41 shows enlarged pads for Pin 1, Pin 8, Pin 9, and Pin 16. Implement multiple vias from the pad to the ground plane to reduce the temperature inside the chip significantly. The dimensions of the expanded pads are at the discretion of the designer and dependent on the available board space.

### EMI CONSIDERATIONS

The dc-to-dc converter section of the [ADM2682E/ADM2687E](#) components must, of necessity, operate at very high frequency to allow efficient power transfer through the small transformers. This creates high frequency currents that can propagate in circuit board ground and power planes, causing edge and dipole radiation. Grounded enclosures are recommended for applications that use these devices. If grounded enclosures are not possible, good RF design practices should be followed in the layout of the PCB. See the [AN-0971 Application Note, Recommendations for Control of Radiated Emissions with \*isoPower\* Devices](#), for more information.

**INSULATION LIFETIME**

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation is dependent on the characteristics of the voltage waveform applied across the insulation. Analog Devices conducts an extensive set of evaluations to determine the lifetime of the insulation structure within the [ADM2682E/ADM2687E](#).

Accelerated life testing is performed using voltage levels higher than the rated continuous working voltage. Acceleration factors for several operating conditions are determined, allowing calculation of the time to failure at the working voltage of interest. The values shown in Table 9 summarize the peak voltages for 50 years of service life in several operating conditions. In many cases, the working voltage approved by agency testing is higher than the 50-year service life voltage. Operation at working voltages higher than the service life voltage listed leads to premature insulation failure.

The insulation lifetime of the [ADM2682E/ADM2687E](#) depends on the voltage waveform type imposed across the isolation barrier. The *i*Coupler insulation structure degrades at different rates, depending on whether the waveform is bipolar ac, unipolar ac, or dc. Figure 42, Figure 43, and Figure 44 illustrate these different isolation voltage waveforms.

Bipolar ac voltage is the most stringent environment. A 50-year operating lifetime under the bipolar ac condition determines the Analog Devices recommended maximum working voltage.

In the case of unipolar ac or dc voltage, the stress on the insulation is significantly lower. This allows operation at higher working voltages while still achieving a 50-year service life. The working voltages listed in Table 9 can be applied while maintaining the 50-year minimum lifetime, provided the voltage conforms to either

the unipolar ac or dc voltage cases. Any cross-insulation voltage waveform that does not conform to Figure 43 or Figure 44 should be treated as a bipolar ac waveform, and its peak voltage should be limited to the 50-year lifetime voltage value listed in Table 9.

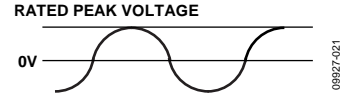


Figure 42. Bipolar AC Waveform

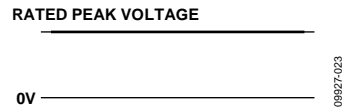
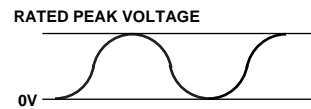


Figure 43. DC Waveform



**NOTES**

- 1. THE VOLTAGE IS SHOWN AS SINUSOIDAL FOR ILLUSTRATION PURPOSES ONLY. IT IS MEANT TO REPRESENT ANY VOLTAGE WAVEFORM VARYING BETWEEN 0 AND SOME LIMITING VALUE. THE LIMITING VALUE CAN BE POSITIVE OR NEGATIVE, BUT THE VOLTAGE CANNOT CROSS 0V.

Figure 44. Unipolar AC Waveform

**ISOLATED SUPPLY CONSIDERATIONS**

The typical output voltage of the integrated *iso*Power dc-to-dc isolated supply is 3.3 V. The isolated supply in the [ADM2682E/ADM2687E](#) is typically capable of supplying a current of 55 mA when the junction temperature of the device is kept below 130°C. This includes the current required by the internal RS-485 circuitry, and typically, no additional current is available on V<sub>ISOOUT</sub> for external applications.

## TYPICAL APPLICATIONS

An example application of the [ADM2682E/ADM2687E](#) for a full-duplex RS-485 node is shown in the circuit diagram of Figure 45. Refer to the PCB Layout section for the recommended placement of the capacitors shown in this circuit diagram. Placement of the  $R_T$  termination resistors depends on the location of the node and the network configuration. Refer to [AN-960 Application Note, RS-485/RS-422 Circuit Implementation Guide](#), for guidance on termination.

Figure 46 and Figure 47 show typical applications of the [ADM2682E/ADM2687E](#) in half duplex and full duplex RS-485 network configurations. Up to 256 transceivers can be connected to the RS-485 bus. To minimize reflections, terminate the line at the receiving end in its characteristic impedance and keep stub lengths off the main line as short as possible. For half-duplex operation, this means that both ends of the line must be terminated because either end can be the receiving end.

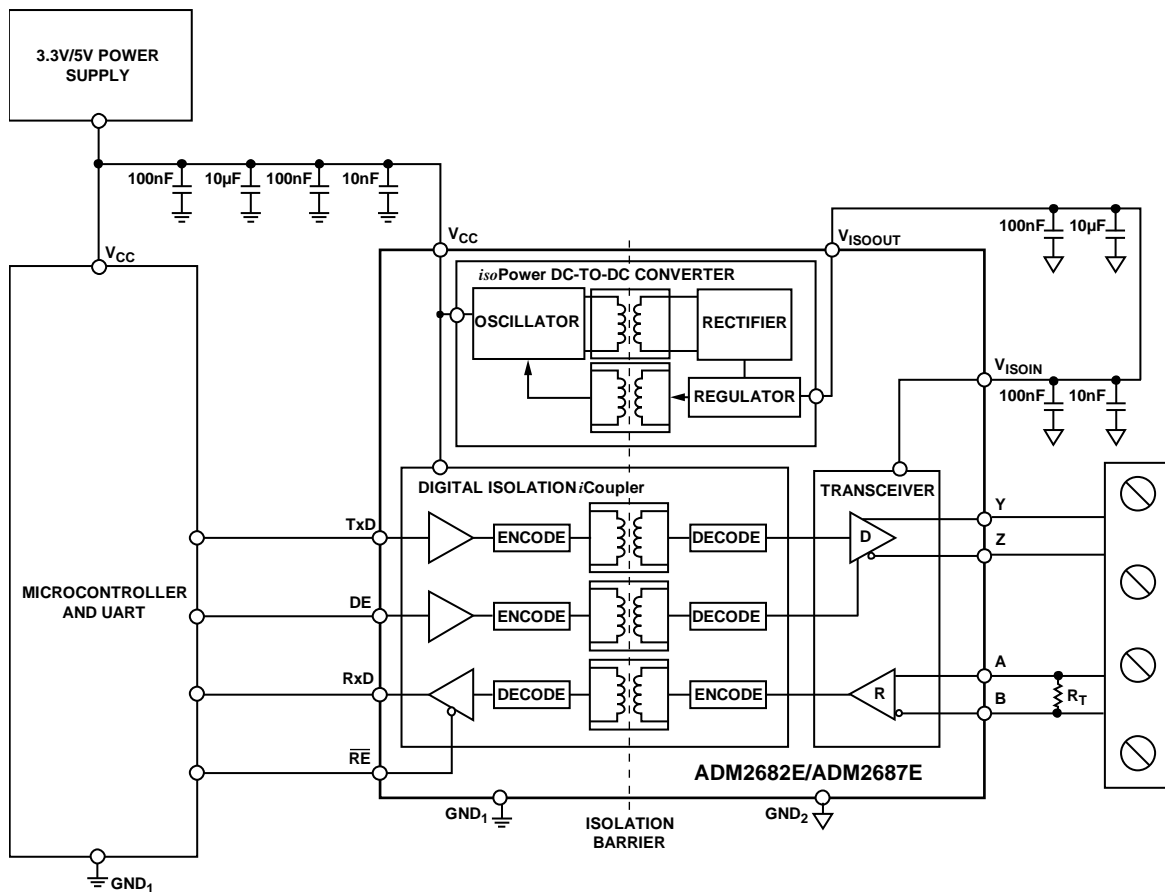
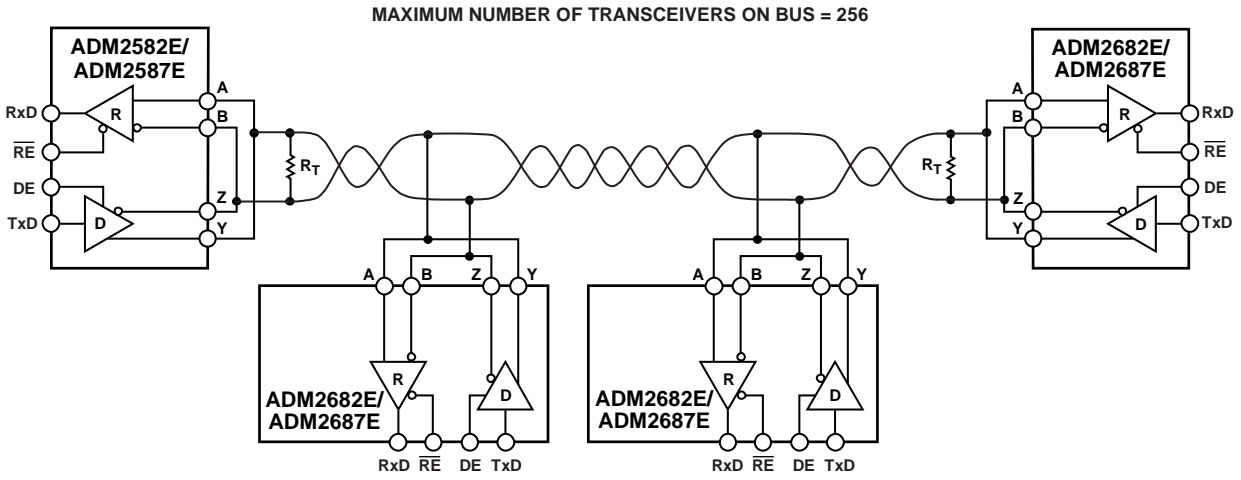


Figure 45. Example Circuit Diagram Using the [ADM2682E/ADM2687E](#)

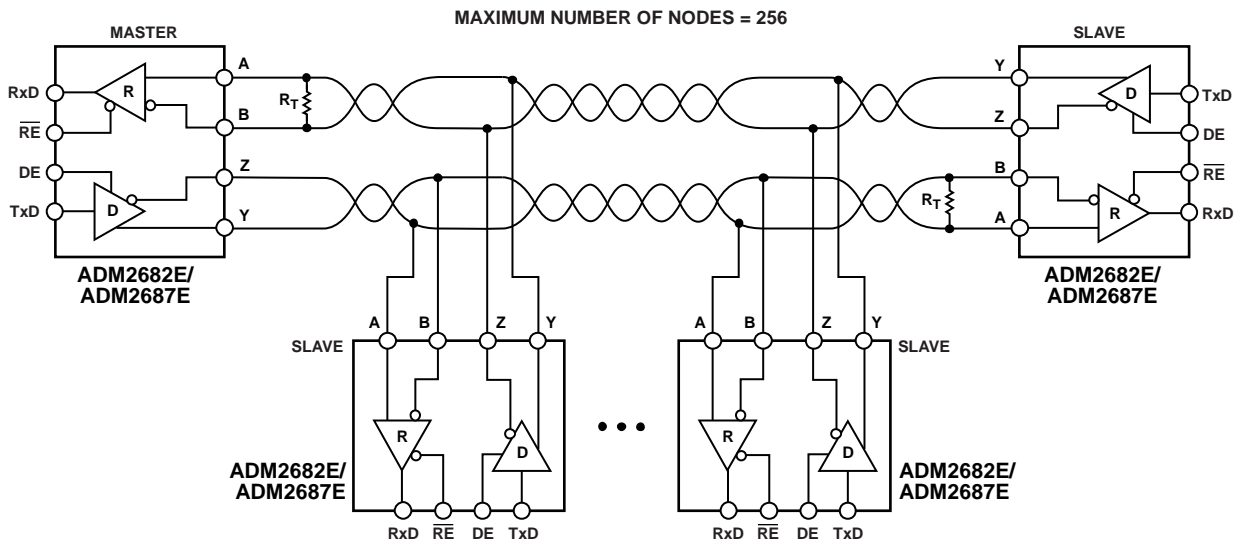
09827124



- NOTES
1.  $R_T$  IS EQUAL TO THE CHARACTERISTIC IMPEDANCE OF THE CABLE.
  2. ISOLATION NOT SHOWN.

Figure 46. ADM2682E/ADM2687E Typical Half Duplex RS-485 Network

09827-027

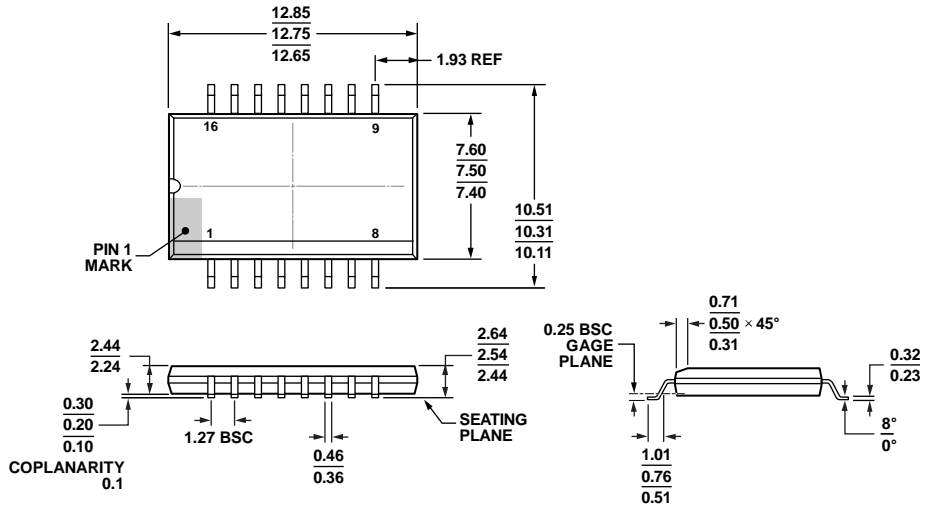


- NOTES
1.  $R_T$  IS EQUAL TO THE CHARACTERISTIC IMPEDANCE OF THE CABLE.
  2. ISOLATION NOT SHOWN.

Figure 47. ADM2682E/ADM2687E Typical Full Duplex RS-485 Network

09827-028

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-013-AC

Figure 48. 16-Lead Standard Small Outline Package with Increased Creepage [SOIC\_IC] Wide Body, (RI-16-2) Dimensions shown in millimeters

11-15/2011-A

ORDERING GUIDE

Model <sup>1</sup>	Data Rate (Mbps)	Temperature Range	Package Description	Package Option
ADM2682EBRIZ	16	-40°C to +85°C	16-Lead SOIC_IC	RI-16-2
ADM2682EBRIZ-RL7	16	-40°C to +85°C	16-Lead SOIC_IC	RI-16-2
ADM2687EBRIZ	0.5	-40°C to +85°C	16-Lead SOIC_IC	RI-16-2
ADM2687EBRIZ-RL7	0.5	-40°C to +85°C	16-Lead SOIC_IC	RI-16-2
EVAL-ADM2682EEBZ			ADM2682E Evaluation Board	
EVAL-ADM2687EEBZ			ADM2687E Evaluation Board	

<sup>1</sup> Z = RoHS Compliant Part.

**NOTES**

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Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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